

## IHM-B module with Trench/Fieldstop IGBT4 and emitter controlled 4 diode

### Features

- Electrical features
  - $V_{CES} = 3300\text{ V}$
  - $I_{C\text{ nom}} = 825\text{ A} / I_{CRM} = 1650\text{ A}$
  - Low  $Q_g$  and  $C_{res}$
  - High DC stability
  - High short-circuit capability
  - Low switching losses
  - Low  $V_{CE,sat}$
  - $T_{vj,op} = 150^\circ\text{C}$
  - Trench IGBT 4
  - Unbeatable robustness
  - $V_{CE,sat}$  with positive temperature coefficient
  - High current density
- Mechanical features
  - ALSiC base plate for increased thermal cycling capability
  - High power density
  - Isolated base plate
  - Package with CTI > 600
  - RoHS compliant



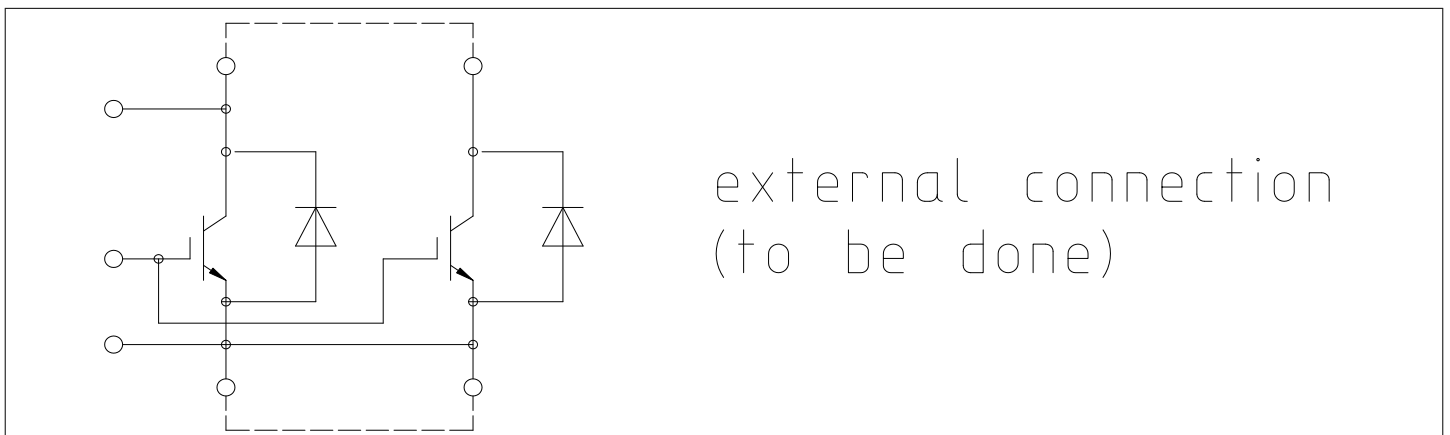
### Potential applications

- High-power converters
- Medium-voltage converters
- Motor drives
- Traction drives
- UPS systems
- Active frontend (energy recovery)

### Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

### Description



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## 1 Package

**Table 1 Insulation coordination**

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	$V_{ISOL}$	RMS, $f = 50$ Hz	6.0	kV
Partial discharge extinction voltage	$V_{isol}$	RMS, $f = 50$ Hz, $Q_{PD} \leq 10$ pC	2.6	kV
DC stability	$V_{CE(D)}$	$T_{vj} = 25$ °C, 100 Fit	2100	V
Material of module baseplate			AlSiC	
Creepage distance	$d_{Creep}$	terminal to heatsink	32.2	mm
Clearance	$d_{Clear}$	terminal to heatsink	19.1	mm
Comparative tracking index	$CTI$		> 600	

**Table 2 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Stray inductance module	$L_{sCE}$			9		nH	
Module lead resistance, terminals - chip	$R_{AA'+CC'}$	$T_C = 25$ °C, per switch		0.12		mΩ	
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_C = 25$ °C, per switch		0.2		mΩ	
Storage temperature	$T_{stg}$		-40		150	°C	
Mounting torque for module mounting	$M$	- Mounting according to valid application note	M6, Screw	4.25		5.75	Nm
Terminal connection torque	$M$	- Mounting according to valid application note	M4, Screw	1.8		2.1	Nm
			M8, Screw	8		10	
Weight	$G$			800		g	

## 2 IGBT, Inverter

**Table 3 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Collector-emitter voltage	$V_{CES}$		$T_{vj} = -40$ °C	3300	V
			$T_{vj} = 150$ °C	3300	
Continuous DC collector current	$I_{CDC}$	$T_{vj\ max} = 150$ °C	$T_C = 105$ °C	825	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{vj\ op}$		1650	A

(table continues...)

**Table 3 (continued) Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit
Gate-emitter peak voltage	$V_{GES}$		$\pm 20$	V

**Table 4 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 825\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$	2.40	2.65	V
			$T_{vj} = 125\ ^\circ C$	3.00		
			$T_{vj} = 150\ ^\circ C$	3.13	3.28	
Gate threshold voltage	$V_{GEth}$	$I_C = 32\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$	5.20	5.80	6.40	V
Gate charge	$Q_G$	$V_{GE} = \pm 15\ V, V_{CC} = 1800\ V$		14		$\mu C$
Internal gate resistor	$R_{Gint}$	$T_{vj} = 25\ ^\circ C$		1.5		$\Omega$
Input capacitance	$C_{ies}$	$f = 1000\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$		93.5		nF
Reverse transfer capacitance	$C_{res}$	$f = 1000\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$		2.67		nF
Collector-emitter cut-off current	$I_{CES}$	$V_{CE} = 3300\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$		5	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$			400	nA
Turn-on delay time (inductive load)	$t_{don}$	$I_C = 825\ A, V_{CC} = 1800\ V, V_{GE} = \pm 15\ V, R_{Gon} = 0.5\ \Omega$	$T_{vj} = 25\ ^\circ C$	0.560		$\mu s$
			$T_{vj} = 125\ ^\circ C$	0.605		
			$T_{vj} = 150\ ^\circ C$	0.615		
Rise time (inductive load)	$t_r$	$I_C = 825\ A, V_{CC} = 1800\ V, V_{GE} = \pm 15\ V, R_{Gon} = 0.5\ \Omega$	$T_{vj} = 25\ ^\circ C$	0.130		$\mu s$
			$T_{vj} = 125\ ^\circ C$	0.150		
			$T_{vj} = 150\ ^\circ C$	0.160		
Turn-off delay time (inductive load)	$t_{doff}$	$I_C = 825\ A, V_{CC} = 1800\ V, V_{GE} = \pm 15\ V, R_{Goff} = 7\ \Omega$	$T_{vj} = 25\ ^\circ C$	3.200		$\mu s$
			$T_{vj} = 125\ ^\circ C$	3.450		
			$T_{vj} = 150\ ^\circ C$	3.500		
Fall time (inductive load)	$t_f$	$I_C = 825\ A, V_{CC} = 1800\ V, V_{GE} = \pm 15\ V, R_{Goff} = 7\ \Omega$	$T_{vj} = 25\ ^\circ C$	0.900		$\mu s$
			$T_{vj} = 125\ ^\circ C$	1.450		
			$T_{vj} = 150\ ^\circ C$	1.650		
Turn-on time (resistive load)	$t_{on\_R}$	$I_C = 500\ A, V_{CC} = 2000\ V, V_{GE} = \pm 15\ V, R_{Gon} = 0.5\ \Omega$	$T_{vj} = 25\ ^\circ C$	1.09		$\mu s$
Turn-on energy loss per pulse	$E_{on}$	$I_C = 825\ A, V_{CC} = 1800\ V, L_\sigma = 85\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 0.5\ \Omega, di/dt = 4700\ A/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$	920		mJ
			$T_{vj} = 125\ ^\circ C$	1450		
			$T_{vj} = 150\ ^\circ C$	1630		

(table continues...)

**Table 4 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-off energy loss per pulse	$E_{off}$	$I_C = 825\text{ A}, V_{CC} = 1800\text{ V}, L_\sigma = 85\text{ nH}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 7\ \Omega, dv/dt = 1700\text{ V}/\mu\text{s} (T_{vj} = 150\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	1100		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	1470		
			$T_{vj} = 150\text{ }^\circ\text{C}$	1580		
SC data	$I_{SC}$	$V_{GE} \leq 15\text{ V}, V_{CC} = 2400\text{ V}, V_{CEmax} = V_{CES} - L_{sCE} * di/dt$	$t_p \leq 10\ \mu\text{s}, T_{vj} \leq 150\text{ }^\circ\text{C}$	3600		A
Thermal resistance, junction to case	$R_{thJC}$	per IGBT			18.0	K/kW
Thermal resistance, case to heat sink	$R_{thCH}$	per IGBT		7.17		K/kW
Temperature under switching conditions	$T_{vjop}$		-40		150	$^\circ\text{C}$

### 3 Diode, Inverter

**Table 5 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$		$T_{vj} = -40\text{ }^\circ\text{C}$	3300	V
			$T_{vj} = 150\text{ }^\circ\text{C}$	3300	
Continuous DC forward current	$I_F$		825	A	
Repetitive peak forward current	$I_{FRM}$	$t_p = 1\text{ ms}$	1650	A	
$I^2t$ - value	$I^2t$	$t_p = 10\text{ ms}, V_R = 0\text{ V}$	$T_{vj} = 125\text{ }^\circ\text{C}$	280	kA <sup>2</sup> s
			$T_{vj} = 150\text{ }^\circ\text{C}$	253	
Maximum power dissipation	$P_{RQM}$		$T_{vj} = 150\text{ }^\circ\text{C}$	2400	kW
Minimum turn-on time	$t_{onmin}$			10	$\mu\text{s}$

**Table 6 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	$V_F$	$I_F = 825\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ }^\circ\text{C}$		2.55	2.95	V
			$T_{vj} = 125\text{ }^\circ\text{C}$		2.30		
			$T_{vj} = 150\text{ }^\circ\text{C}$		2.20	2.50	

(table continues...)

**Table 6 (continued) Characteristic values**

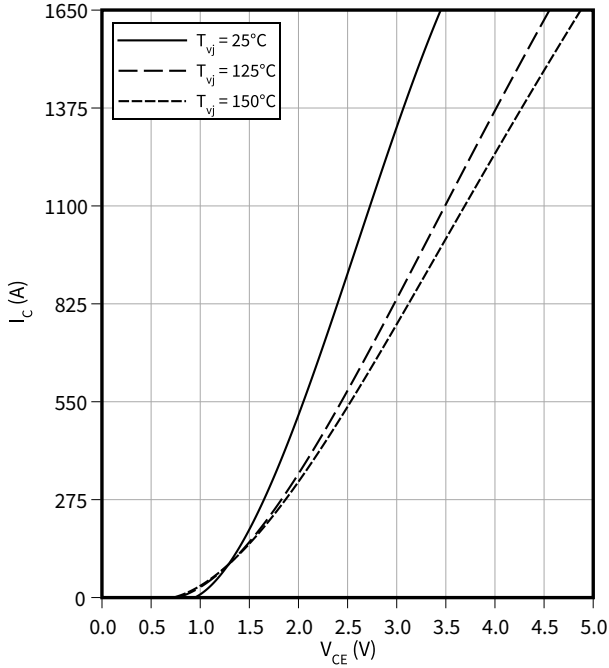
Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current	$I_{RM}$	$V_{CC} = 1800\text{ V}$ , $I_F = 825\text{ A}$ , $V_{GE} = -15\text{ V}$ , $-di_F/dt = 4700\text{ A}/\mu\text{s}$ ( $T_{vj} = 150\text{ }^\circ\text{C}$ )	$T_{vj} = 25\text{ }^\circ\text{C}$		1180	A
			$T_{vj} = 125\text{ }^\circ\text{C}$		1240	
			$T_{vj} = 150\text{ }^\circ\text{C}$		1250	
Recovered charge	$Q_r$	$V_{CC} = 1800\text{ V}$ , $I_F = 825\text{ A}$ , $V_{GE} = -15\text{ V}$ , $-di_F/dt = 4700\text{ A}/\mu\text{s}$ ( $T_{vj} = 150\text{ }^\circ\text{C}$ )	$T_{vj} = 25\text{ }^\circ\text{C}$		430	$\mu\text{C}$
			$T_{vj} = 125\text{ }^\circ\text{C}$		830	
			$T_{vj} = 150\text{ }^\circ\text{C}$		970	
Reverse recovery energy	$E_{rec}$	$V_{CC} = 1800\text{ V}$ , $I_F = 825\text{ A}$ , $V_{GE} = -15\text{ V}$ , $-di_F/dt = 4700\text{ A}/\mu\text{s}$ ( $T_{vj} = 150\text{ }^\circ\text{C}$ )	$T_{vj} = 25\text{ }^\circ\text{C}$		390	mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$		875	
			$T_{vj} = 150\text{ }^\circ\text{C}$		1050	
Thermal resistance, junction to case	$R_{thJC}$	per diode			25.2	K/kW
Thermal resistance, case to heat sink	$R_{thCH}$	per diode		9.43		K/kW
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		150	$^\circ\text{C}$

## 4 Characteristics diagrams

### Output characteristic (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

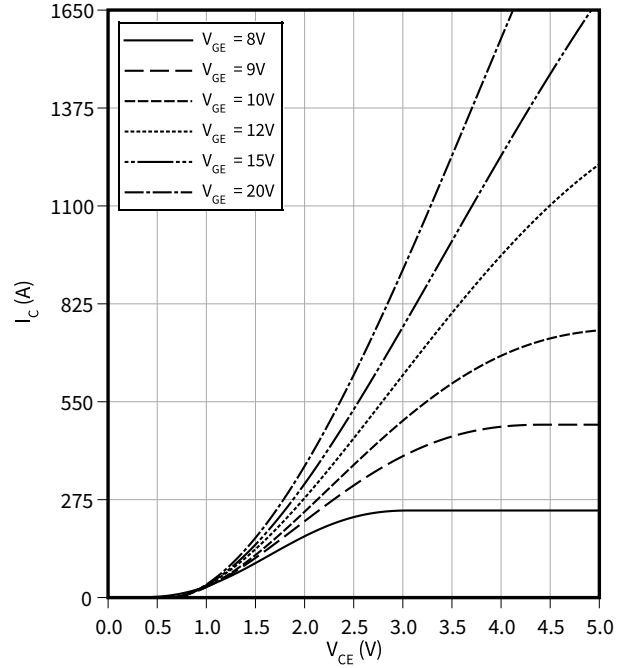
$$V_{GE} = 15 \text{ V}$$



### Output characteristic field (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

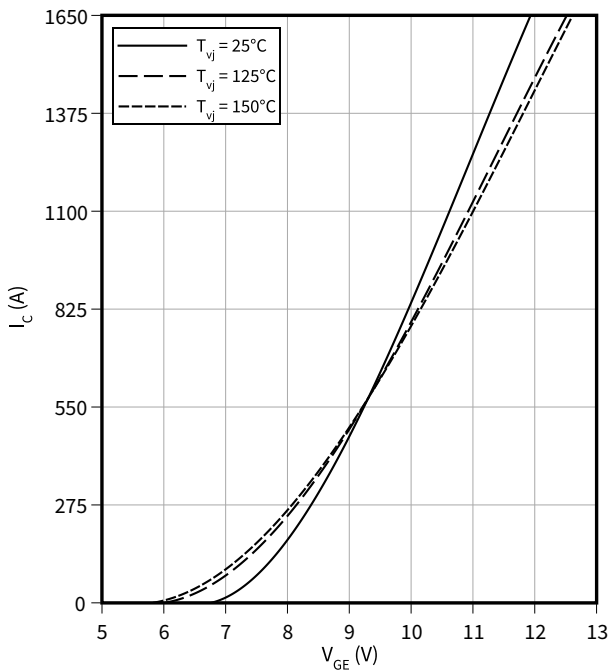
$$T_{vj} = 150 \text{ °C}$$



### Transfer characteristic (typical), IGBT, Inverter

$$I_C = f(V_{GE})$$

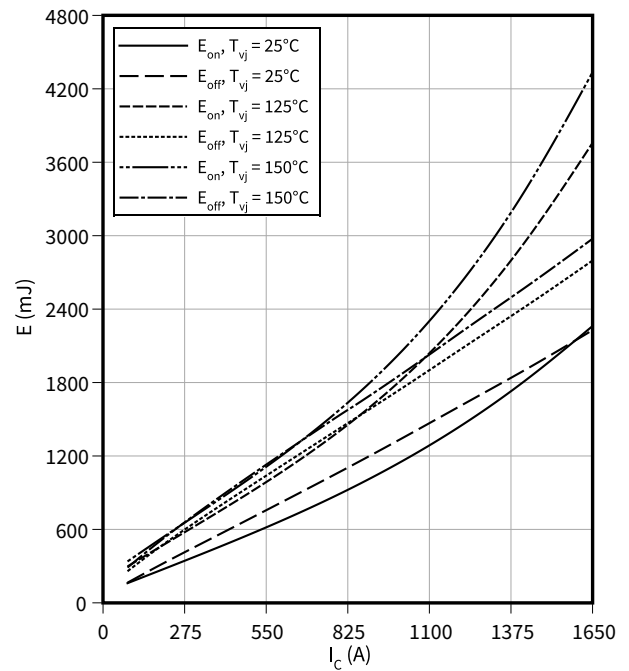
$$V_{CE} = 20 \text{ V}$$



### Switching losses (typical), IGBT, Inverter

$$E = f(I_C)$$

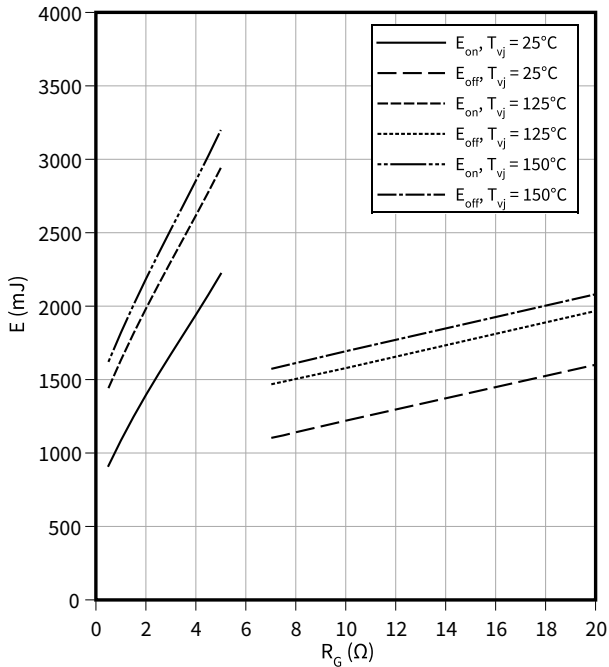
$$R_{Goff} = 7 \text{ } \Omega, R_{Gon} = 0.5 \text{ } \Omega, V_{CC} = 1800 \text{ V}, V_{GE} = \pm 15 \text{ V}$$



**Switching losses (typical), IGBT, Inverter**

$E = f(R_G)$

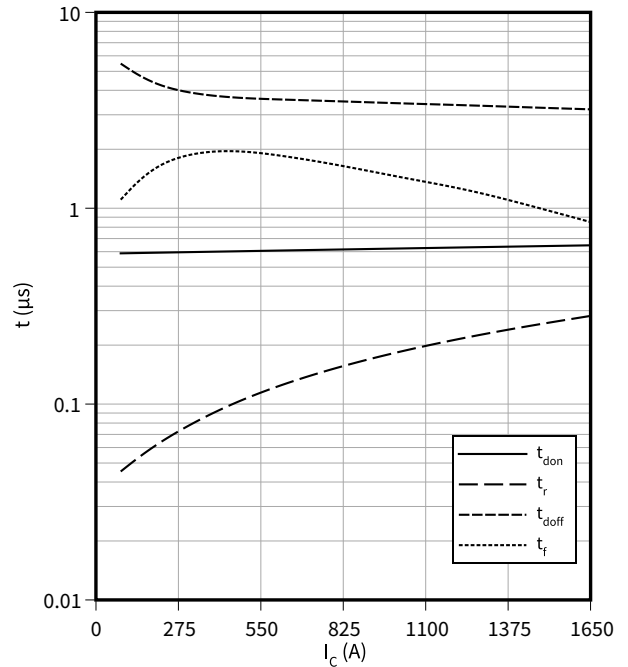
$I_C = 825 \text{ A}$ ,  $V_{CC} = 1800 \text{ V}$ ,  $V_{GE} = \pm 15 \text{ V}$



**Switching times (typical), IGBT, Inverter**

$t = f(I_C)$

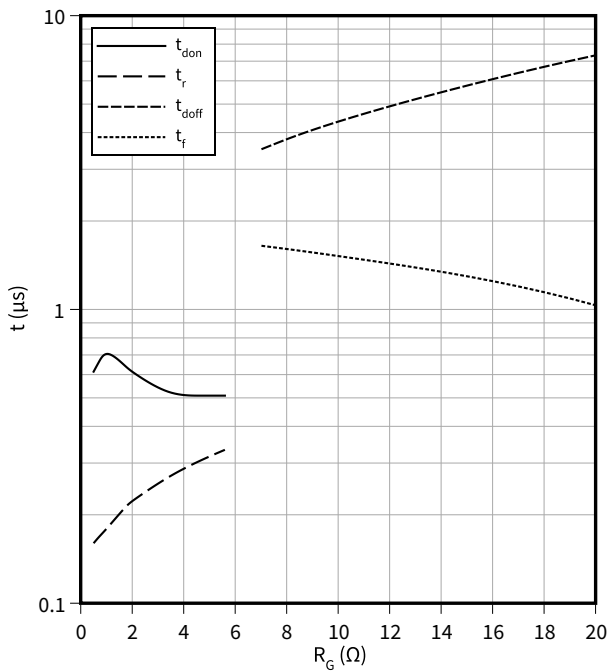
$R_{Goff} = 7 \Omega$ ,  $R_{Gon} = 0.5 \Omega$ ,  $V_{CC} = 1800 \text{ V}$ ,  $V_{GE} = \pm 15 \text{ V}$ ,  $T_{vj} = 150 \text{ }^\circ\text{C}$



**Switching times (typical), IGBT, Inverter**

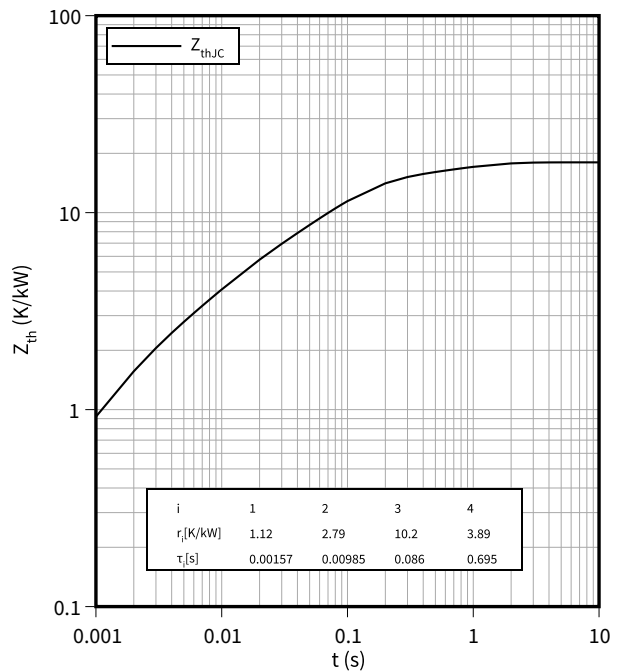
$t = f(R_G)$

$I_C = 825 \text{ A}$ ,  $V_{CC} = 1800 \text{ V}$ ,  $V_{GE} = \pm 15 \text{ V}$ ,  $T_{vj} = 150 \text{ }^\circ\text{C}$



**Transient thermal impedance, IGBT, Inverter**

$Z_{th} = f(t)$



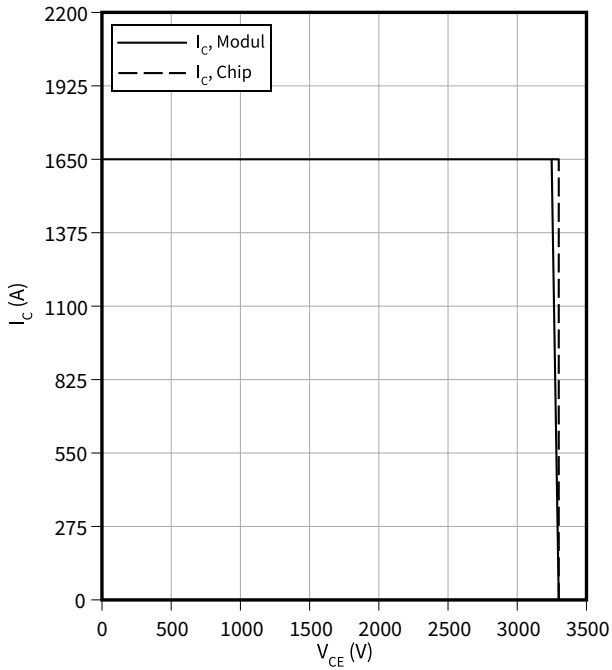


4 Characteristics diagrams

**Reverse bias safe operating area (RBSOA), IGBT, Inverter**

$I_C = f(V_{CE})$

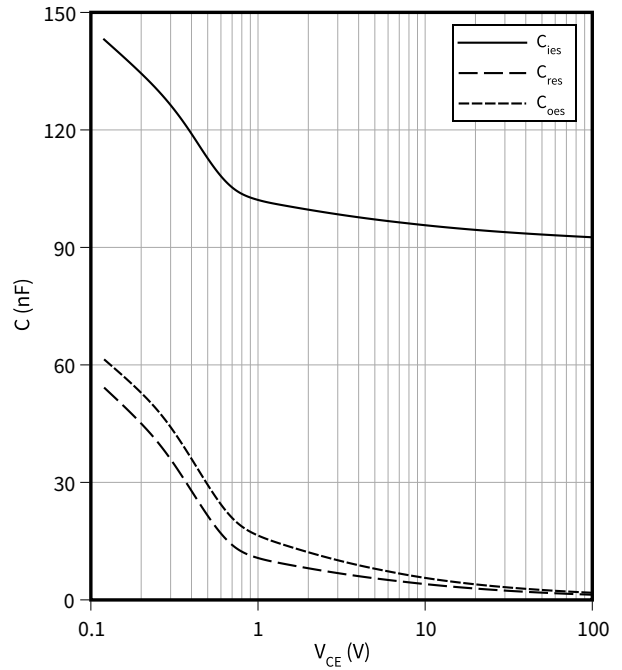
$R_{Goff} = 7 \Omega$ ,  $V_{GE} = 15 \text{ V}$ ,  $T_{vj} = 150 \text{ }^\circ\text{C}$



**Capacity characteristic (typical), IGBT, Inverter**

$C = f(V_{CE})$

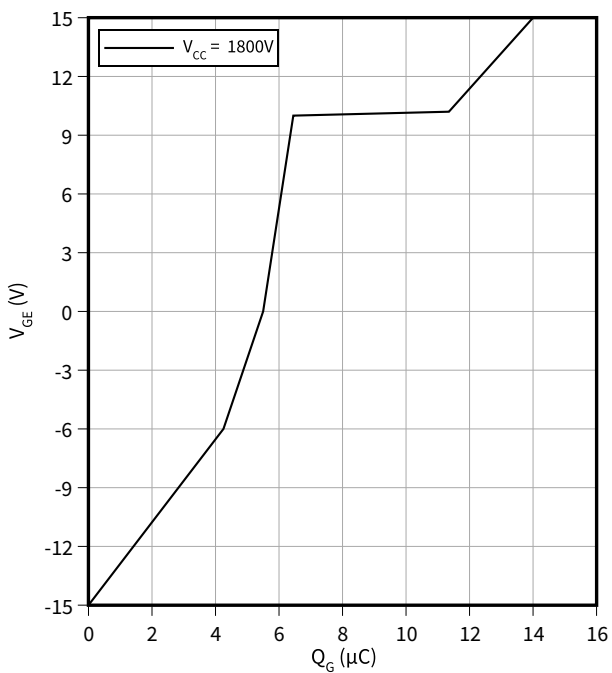
$f = 1000 \text{ kHz}$ ,  $V_{GE} = 0 \text{ V}$ ,  $T_{vj} = 25 \text{ }^\circ\text{C}$



**Gate charge characteristic (typical), IGBT, Inverter**

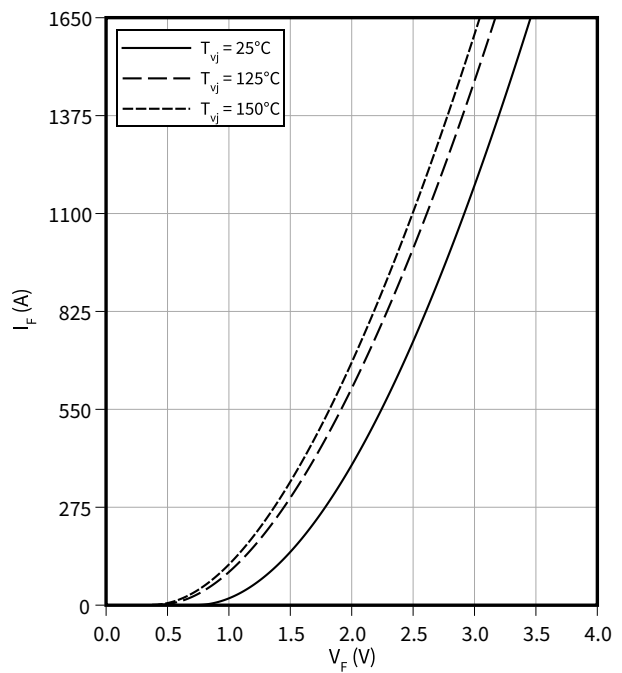
$V_{GE} = f(Q_G)$

$I_C = 825 \text{ A}$ ,  $T_{vj} = 25 \text{ }^\circ\text{C}$



**Forward characteristic (typical), Diode, Inverter**

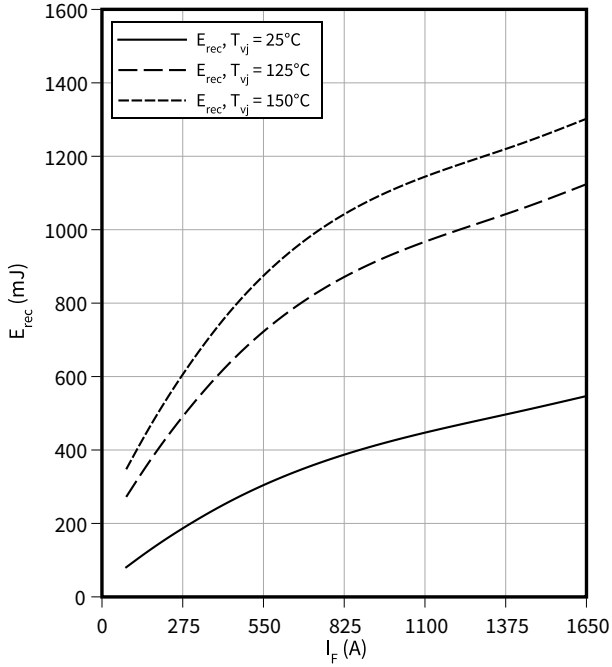
$I_F = f(V_F)$



**Switching losses (typical), Diode, Inverter**

$E_{rec} = f(I_F)$

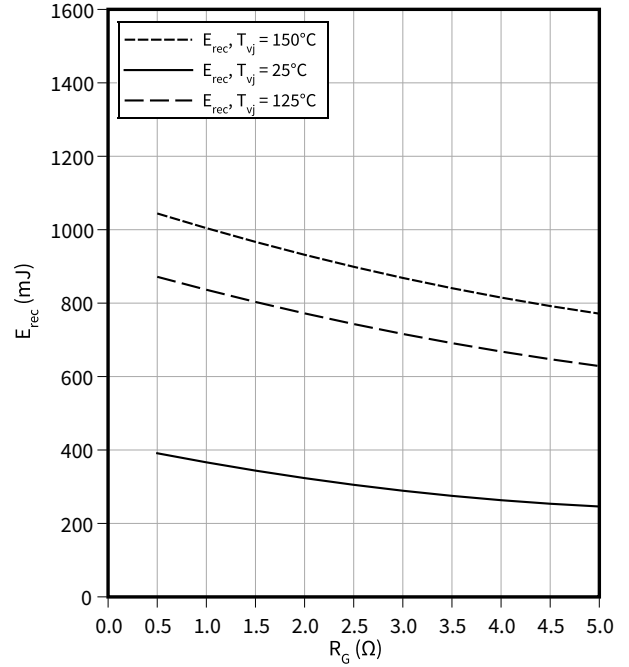
$V_{CE} = 1800\text{ V}$ ,  $R_{Gon} = R_{Gon}(IGBT)$



**Switching losses (typical), Diode, Inverter**

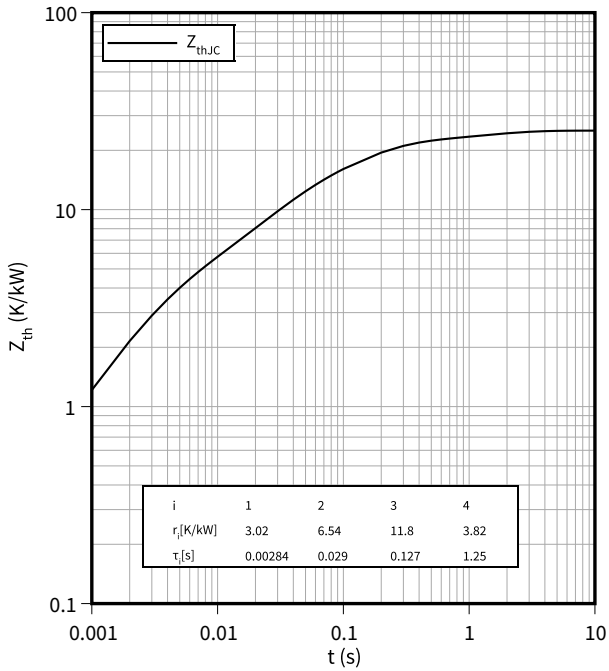
$E_{rec} = f(R_G)$

$V_{CE} = 1800\text{ V}$ ,  $I_F = 825\text{ A}$



**Transient thermal impedance, Diode, Inverter**

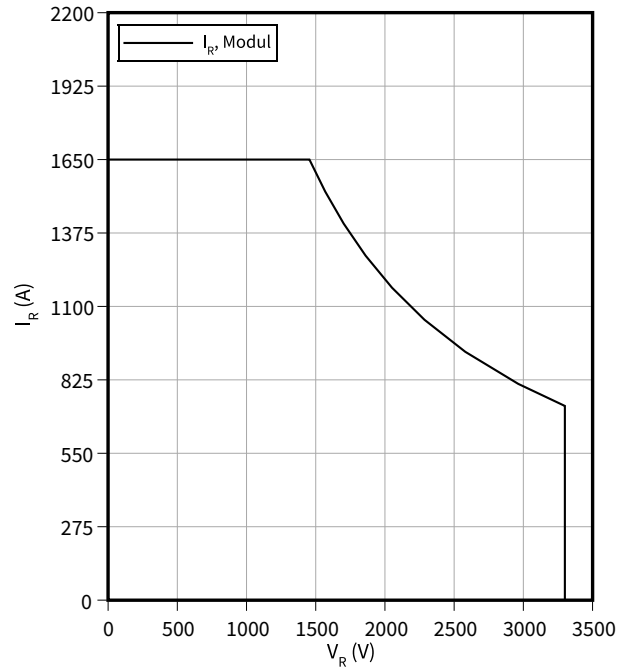
$Z_{th} = f(t)$



**Safe operating area (SOA), Diode, Inverter**

$I_R = f(V_R)$

$T_{vj} = 150\text{ °C}$



## 5 Circuit diagram

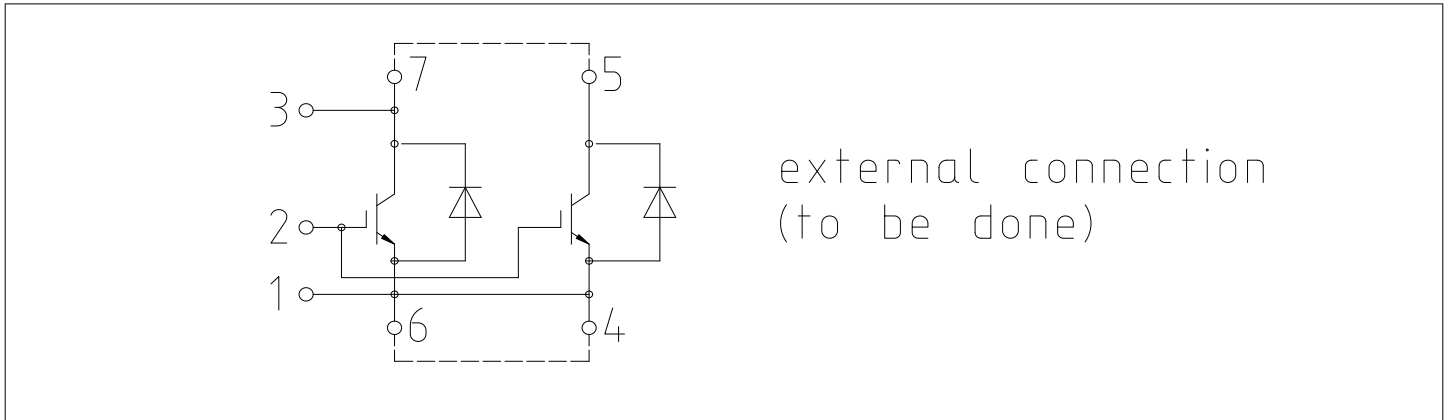


Figure 1

## 6 Package outlines

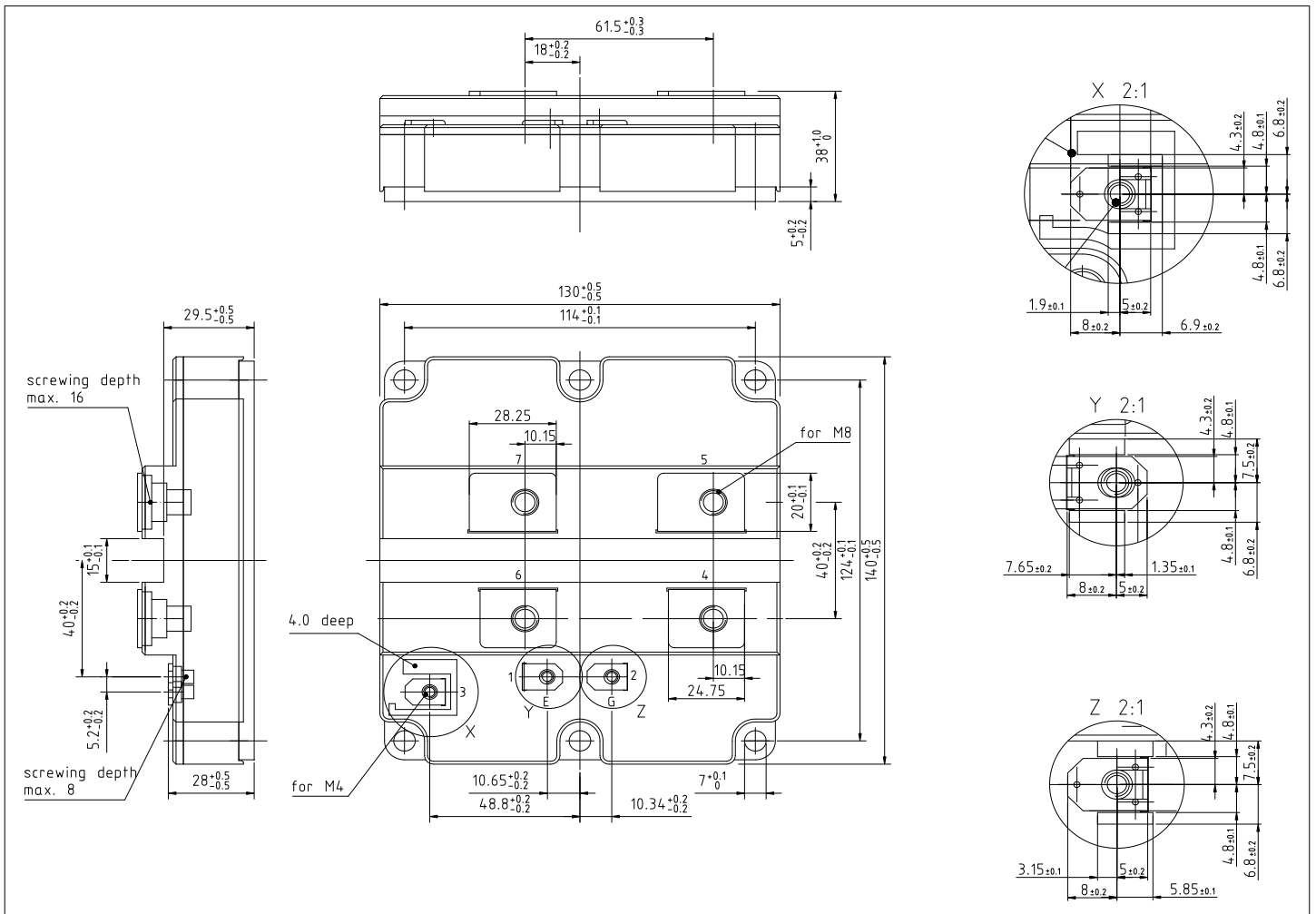


Figure 2

## 7 Module label code


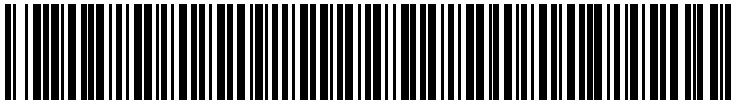
Module label code			
Code format	Data Matrix	Barcode Code128	
Encoding	ASCII text	Code Set A	
Symbol size	16x16	23 digits	
Standard	IEC24720 and IEC16022	IEC8859-1	
Code content	<i>Content</i> Module serial number Module material number Production order number Date code (production year) Date code (production week)	<i>Digit</i> 1 - 5 6 - 11 12 - 19 20 - 21 22 - 23	<i>Example</i> 71549 142846 55054991 15 30
Example	<div style="display: flex; justify-content: space-around; align-items: center;"> <div style="text-align: center;">  71549142846550549911530                 </div> <div style="text-align: center;">  71549142846550549911530                 </div> </div>		

Figure 3

## Revision history

Document revision	Date of release	Description of changes
0.10	2020-12-17	
0.10	2021-01-28	
1.10	2021-03-16	
1.20	2021-10-15	Final datasheet
1.30	2022-11-22	Final datasheet

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**Document reference**

**IFX-AAK420-005**

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